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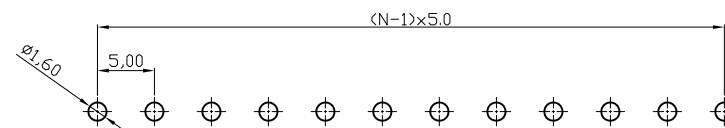
6

7

A

A

P.C.B. LAYOUT



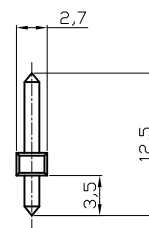
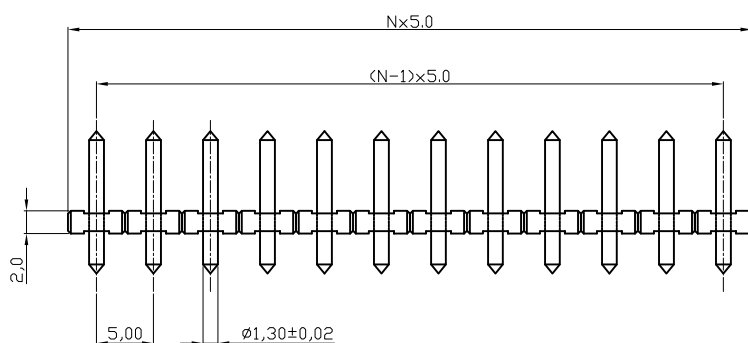
B

B

C

C

N = Number of contact



Material:

Solid PIN: Brass(CuZn)

Surface of solder tail: Matte Tin plated ④

Insulator(housing): Thermoplastic (UL94V-0)

Electrical:




Voltage rating: 300V 300V 300V

Current rating: 10A 12A 15A

Withstanding Voltage: 1.6KV 2.5KV 2.5KV

Operating temperature: -40°C to +115°C

Soldering temperature: 250°C±10°C/5 Sec

Safety Approval:   

D

D


E

E

F

F

RoHS compliant
Unit: mm

Scale	Free						Date	Name	Customer-No.
TOLERANCE						Drawn	07.12.2006	Hellwig	ASSMANN WSW-No. A-TB500-OPxx
X.	±0.50								
X.X	±0.30	④	Update the plating to Matte Tin	23.07.2014	Amy	Approved	23.07.2014	Amy	
X.XX	±0.10	③	Update	29.07.2009	Dean				
DIM	TOL	②	Update technical date	28.07.2008	N.Schulz				Drawing-No.
X.°	±1°	①	Drawn	07.12.2006	Hellwig				ASS 1157 CO
Angle	TOL	Id.	Modification	Date	Name			Replace	rev04
									Sheet

G

G

H

H

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SV1071